

### **FEATURES**

Surface Mounting Design 4.5\*3.2\*2.7mm

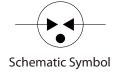
High Current Handling Capability 2000A @ 8/20 µs

Low Capacitance and Insertion Loss

Quick Response and Long Service Life

Moisture sensitivity level: Level 1





## **APPLICATION INFORMATION**

Communication equipment.
Repeaters, Modems
Telephone Interface,Line cards.
Data communication equipment.

## **AGENCY APPROVALS**

lcon	Solderability		
RoHS	Compliance with 2011/65/EU		
HF	Compliance with IEC61249-2-21:2003		
<b>P6</b>	Mean lead free		
<b>R</b> .	UL Certificated E505857		

# **PRODUCT CHARACTERISTICS**

Lead Material	<b>Body Material</b>	Terminal Finish
Copper or Fe-Ni alloy	Ceramics	100% Matte-Tin Plated



### **ELECTRICAL PARAMETER**

Parameter	Condition	Rating	Unit
DC Blocking Voltage 1)	100V/s	320-480	
Impulse Spark-over Voltage	At 1kV/μs	for 99 % of measured values ≤ 1000	V
impuise spark-over voltage	At 1kV/μs	Typical values of distribution ≤ 950	V
Impulse Discharge Current 2)	8/20µs	2000	А
Insulation Resistance	DC=100V	≥ 1	GΩ
Capacitance at 1MHz	V <sub>DC</sub> =0.5V	≤ 1.0	рF
Operating And Storage Temperature		-40-125	°C

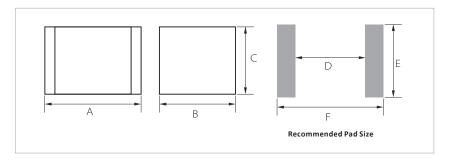
<sup>1)</sup> In ionized mode

## **ENVIRONMENTAL RELIABILITY CHARACTERISTICS**

Testing items	Technical standards	
High Temperature Storage Test	Temperature: 85°C ;Time:2H	
Low Temperature Storage Test	Temperature: -40°C ; Time:2H	
Vibration	Frequency: 10-500Hz ; Amplitude: 0.15mm ; Time:45min	
Resistance of soldering heat	Temperature: 260±5°C; Time of dip soldering: 10s, 1time	

**NOTE:** Up-screen program can be specified by customer's request via contacting Semiware service

## PRODUCT DIMENSIONS AND RECOMMENDED SOLDERING PAD



Ref. mm		
А	4.5±0.3mm	
В	3.2±0.3mm	
С	2.7±0.3mm	
D	2.8mm	
E	4.0mm	
F	5.2mm	

<sup>2)</sup> Terms and waveforms in accordance with ITU-T Rec. K. 12; IEC 61643-311  $\,$ 

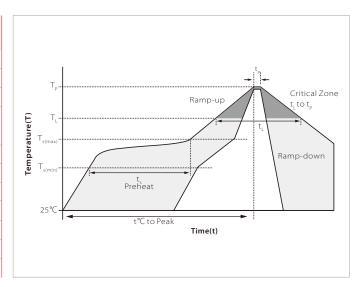


# **SOLDERABILITY TEST**

Solderability		
Solder Pot Temperature	Solder Dwell Time	
245°C ± 5°C	4-6 seconds	

# **REFLOW PROFILE**

Reflow Condition		Lead-free assembly
	Temperature Min	150°C
Pre Heat	Temperature Max	200°C
	Time(min to max)	60 – 180 secs
Average ra	amp up rate (Liquidus)Temp $(T_L)$ to peak	3°C/second max
T <sub>s(max)</sub> to T <sub>L</sub> - Ramp-up Rate		J C/3eCondinax
D - A	Temperature (T₁) (Liquidus)	217℃
Reflow	Time(min to max)( $t_s$ )	60 – 150 seconds
PeakTemperature (T <sub>p</sub> )		260°C
Time within 5°C of actual peak Temperature (tp)		20-40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T,)		8 minutes max.
Do not exceed		260°C



## **ORDERING INFORMATION**

Part Number	Size	QTY/Reel	Reel Size
SG4532B400	4.5*3.2*2.7mm	2500PCS	13"



### Headquarters

No.3387 Shendu Road Pujiang I&E Park Minhang Shanghai China 201000

#### Hotline

400-021-5756

#### Web

Https://www.semiware.com

#### Sales Center

Tel: 86-21-3463-7458 Email: sales18@semiware.com

#### **Customer Service**

Tel: 86-21-5484-1001 Email: sales17@semiware.com

### **Technical Support**

Tel: 86-21-3463-7654 Email: fae01@semiware.com

### **Complaint & Suggestions**

Tel: 86-21-3463-7172 Ext: 8868 Email: cs03@semiware.com

#### By QR Code





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